Electronic Components

Real-world components, network elements, and network models

Real-world electronic components

Show intended electrical behavior over a limited operating range:

- Temperature - Force
- Voltage
- Current
- Frequency - H-field
- Time - etc.
- Charge storage and generation of / susceptibility to E-fields

- Undesired physical side effects

- Magnetic flux storage and generation of / susceptibility to H-fields

- Non-ideal electrical properties of used materials that determine the intended electrical behavior

- Temperature, time, and frequency dependency of conductivity, permeability and permittivity

- Power dissipation, heat capacity and self heating
- Generation of / susceptibility to mechanical forces
- Distibuted character of vector fields: E. H. F. v. T. etc.

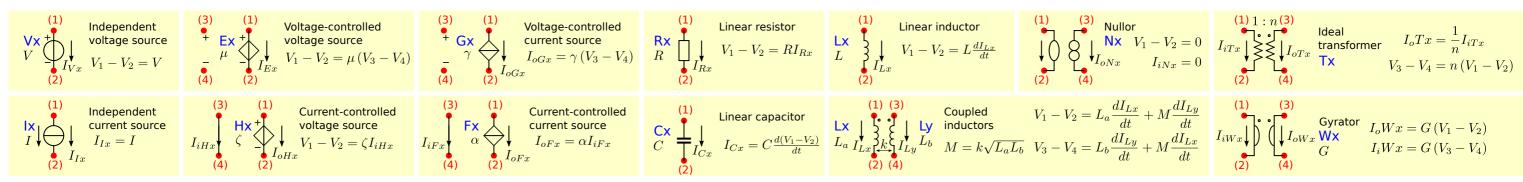
Elaborate component models that sufficiently accurate describe the behavior over the desired operating range Use different models for:

- Nonlinear and non-stationary behavior
- Small-signal dynamic behavior
- Noise behavior
- Use lumped element models for (quasi) static vector fields and distributed element models for dynamic vector fields

Network elements (linear, time-invariant: SLiCAP) Abstractions that model specific electrical behavior

- Illumination

- E-field



Network models of electronic components Intended

Component

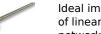


- Thick film: low-cost

Capacitors

Inductors

- Wire wound: high power



Nonideal behavior depends on technology used:

- Metail foil: low-noise, high accuracy, high stability

Nonideal behavior depends on the dielectric used:

- Electrolitic: Polerized, high capacitance values

- Ceramic: NP0, GOG, high temperature stability

- Film: High current, high stability, high accuracy

Nonideal behavior depends on core material, wire

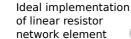
- Air coil, silvered copper: high frequencies, high Q

- Low capacitive winding methods: high self-resonance

type, and winding method:

- Litze wire: low skin effect

- Iron powder core: soft saturation



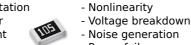
Ideal implementation of linear capacitor

Ideal implementation

of linear inductor

network element

network element



- Power failure
- Self heating
- Ageing - Temperature sensitivity
- Self / mutual capacitance

Other aspects

- Self / mutual inductance
- Frequency dependency
- Nonlinearity - Voltage breakdown
- Inrush current breakdown
- Charge leakage
- Power dissipation - Noise generation
- Self heating
- Ageing
 - Temperature sensitivity
 - Mutual capacitance
 - Self / mutual inductance
 - Frequency dependency - Acoustic noise generation

 - Nonlinearity
 - Voltage breadown - Saturation
 - Power dissipation
 - Noise generation
 - Self heating
 - Ageing
 - Temperature sensitivity
 - Self / mutual capacitance - Mutual inductance
 - Frequency dependency



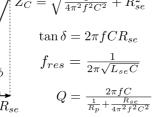
- Acoustic noise generation

Example

modeling small-signal dynamic behavior

R

 $X_C = \frac{1}{2\pi fC}$ $\sqrt{\frac{1}{4\pi^2 f^2 C^2} + R_c^2}$





Transformers

Component

network element

- Resistive losses - Core losses - Self heating

Other aspects

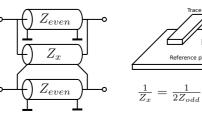
 Self resonance - Capacitive coupling

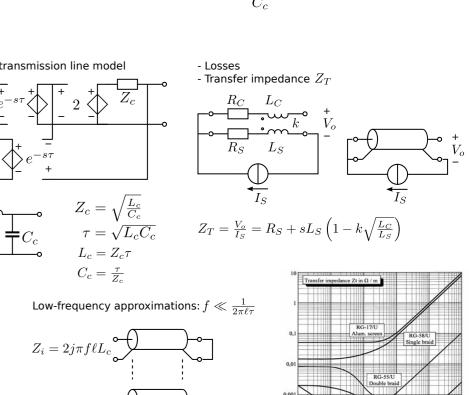
Interconnections

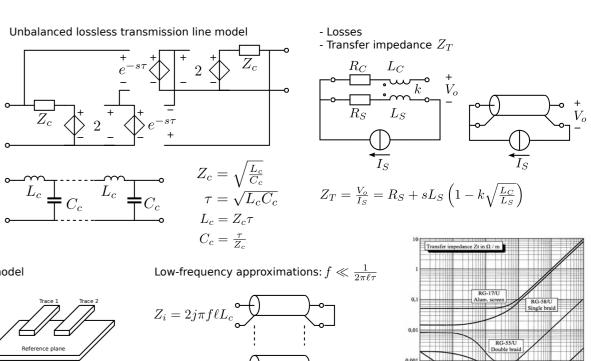
Characteristic

- impedance L_c Inductance per
- unit of length C_c Capacitance per
- unit of length τ Delay per unit of length

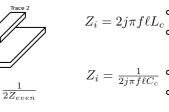
Balanced transmission line model







Example





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Intended Ideal implementation of ideal transformer

- Magnetisation inductance - Leakage inductance - Voltage breakdown - Saturation

Einstein: "Models should be as simple as possible, but not simpler" Box: "All models are wrong, but some are useful

SPICE B-sources

Controlled voltage or current sources that can have - Laplace expressions - Nonlinear expressions

- Logical expressions

